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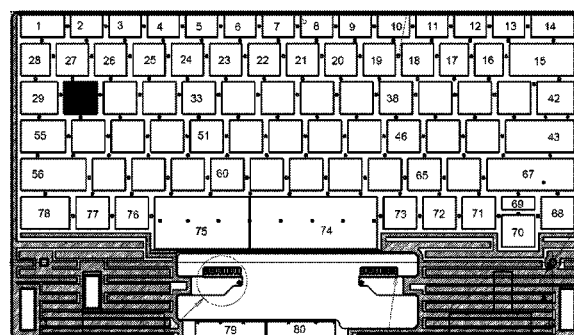
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Whitt, III et al.(10) **Pub. No.: US 2017/0147084 A1**(43) **Pub. Date: May 25, 2017**(54) **INPUT DEVICE SECURING TECHNIQUES**(71) Applicant: **Microsoft Technology Licensing, LLC**,
Redmond, WA (US)(72) Inventors: **David Otto Whitt, III**, Sammamish,
WA (US); **Timothy C. Shaw**,
Sammamish, WA (US); **Rob Huala**,
Bellevue, WA (US); **David C.**
Vandervoort, Seattle, WA (US);
Matthew David Mickelson, Seattle,
WA (US); **Christopher Harry**
Stoumbos, Sammamish, WA (US); **Joel**
Lawrence Pelley, Bellevue, WA (US);
Todd David Pleake, Sammamish, WA
(US); **Hua Wang**, Sammamish, WA
(US)(73) Assignee: **Microsoft Technology Licensing, LLC**,
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on Mar. 2, 2012, provisional application No. 61/606,
313, filed on Mar. 2, 2012, provisional application
No. 61/606,333, filed on Mar. 2, 2012, provisional
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(57)

ABSTRACT

Input device adhesive techniques are described. A pressure sensitive key includes a sensor substrate having one or more conductors, a spacer layer, and a flexible contact layer. The spacer layer is disposed proximal to the sensor substrate and has at least one opening. The flexible contact layer is spaced apart from the sensor substrate by the spacer layer and configured to flex through the opening in response to an applied pressure to initiate an input. The flexible contact layer is secured to the spacer layer such that at first edge, the flexible contact layer is secured to the spacer layer at an approximate midpoint of the first edge and is not secured to the spacer along another portion of the first edge and at a second edge, the flexible contact layer is not secured to the spacer layer along an approximate midpoint of the second edge.

900



902

904

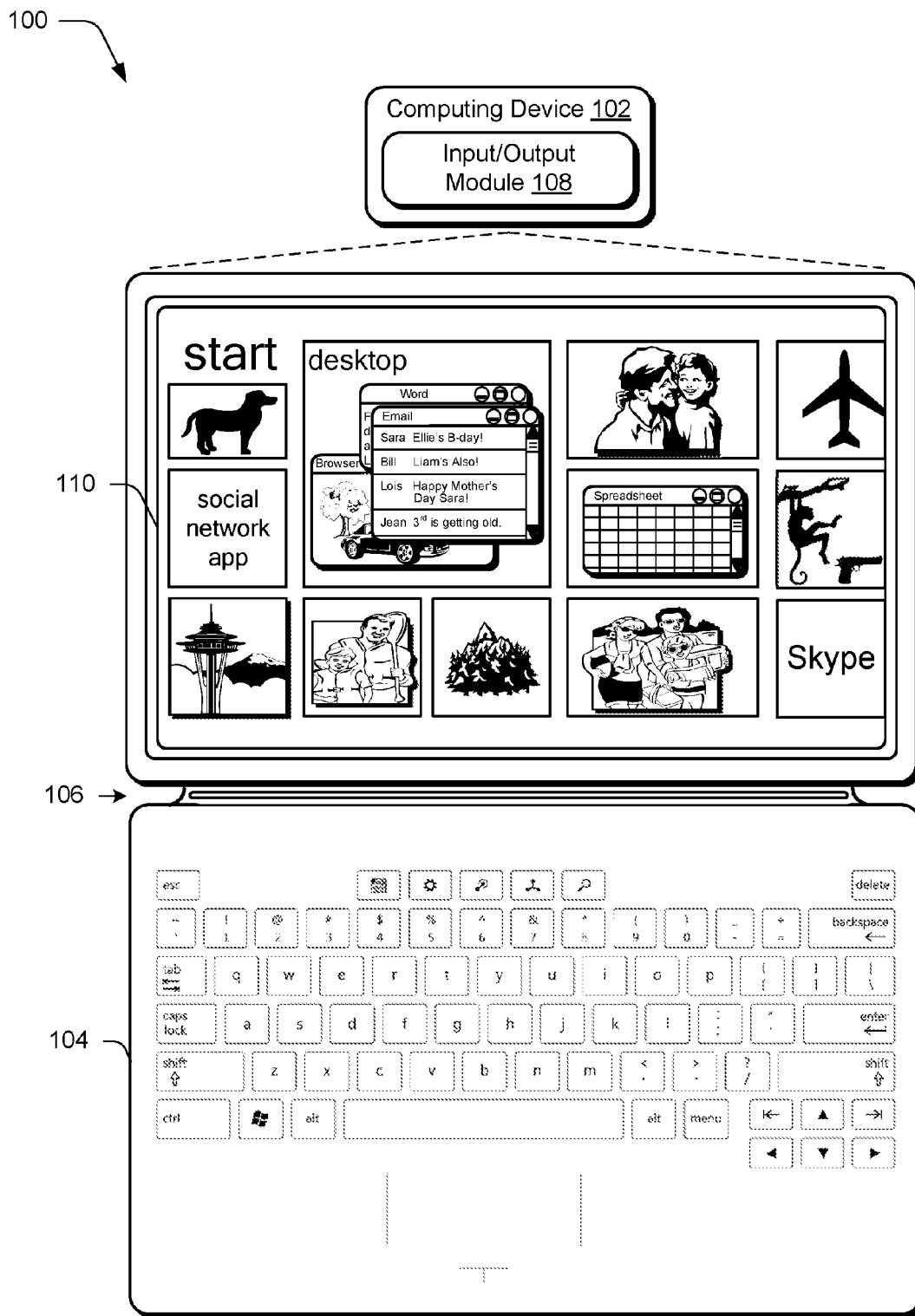


Fig. 1

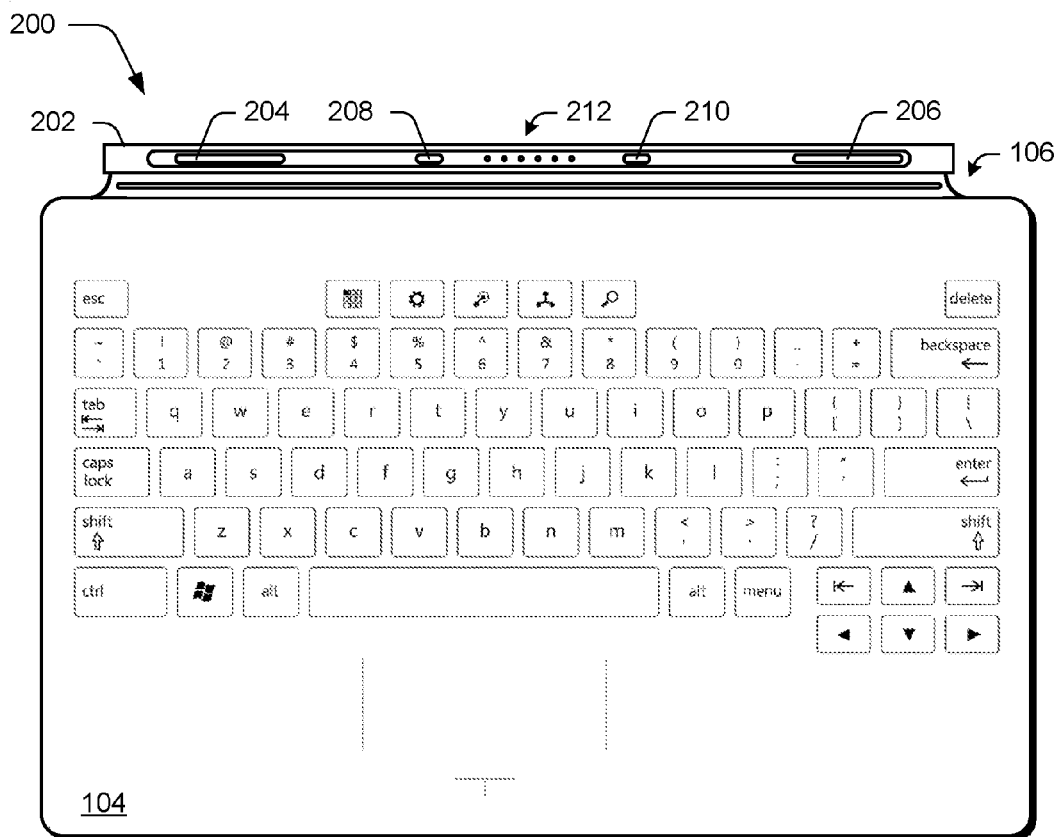


Fig. 2

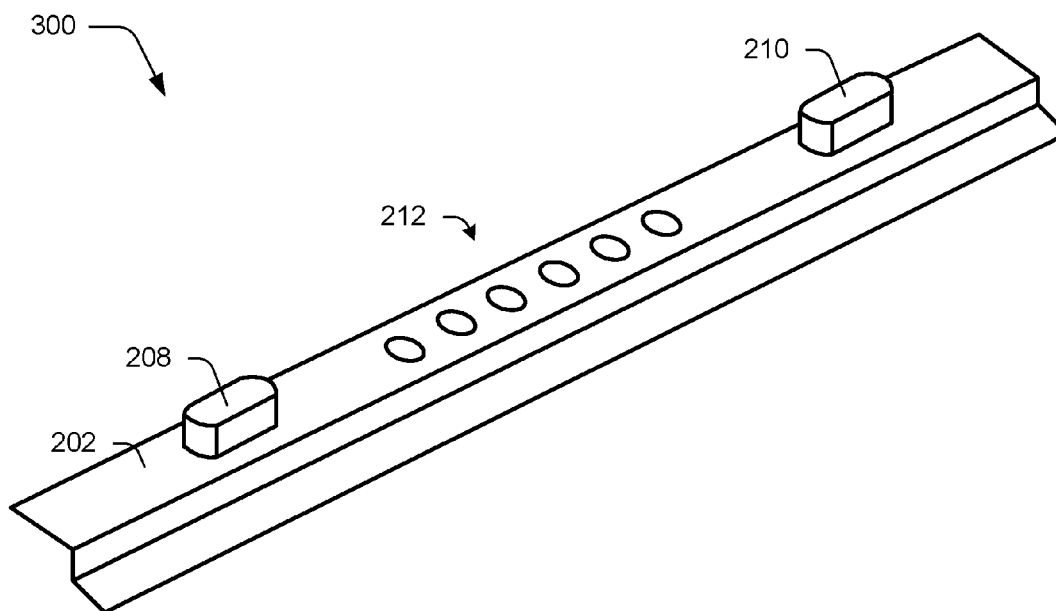


Fig. 3

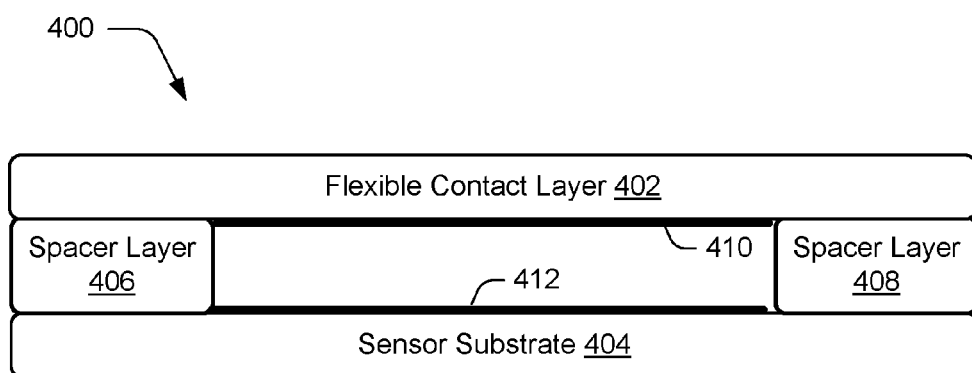


Fig. 4

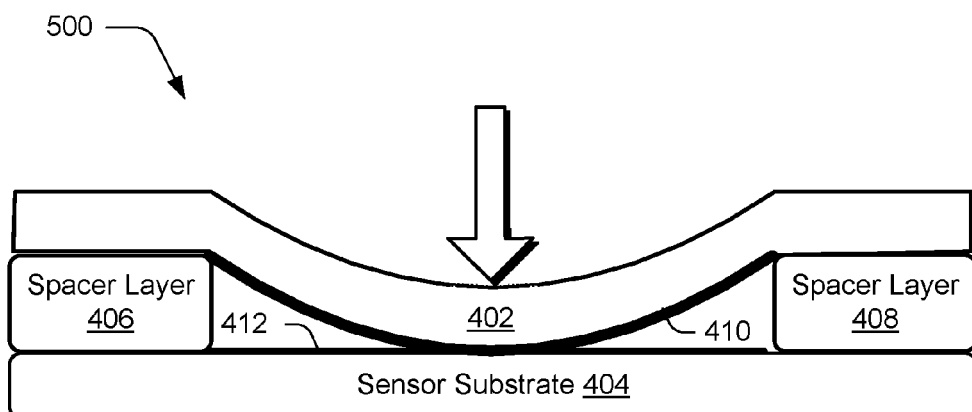


Fig. 5

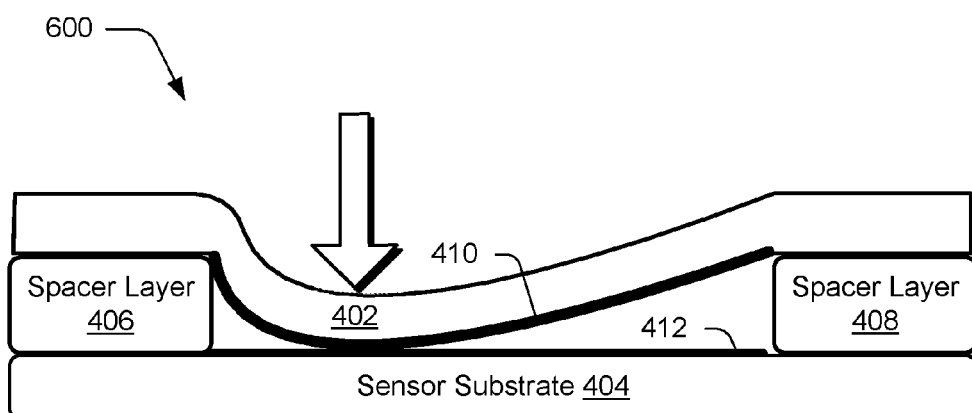


Fig. 6

700

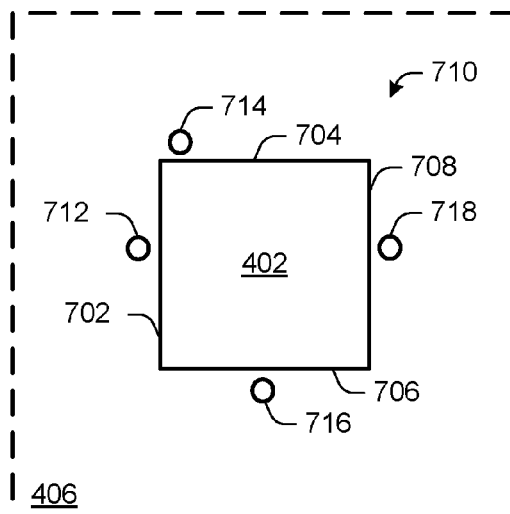


Fig. 7

800

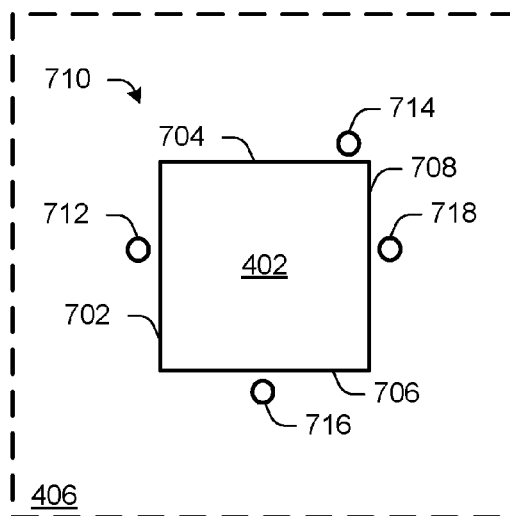


Fig. 8

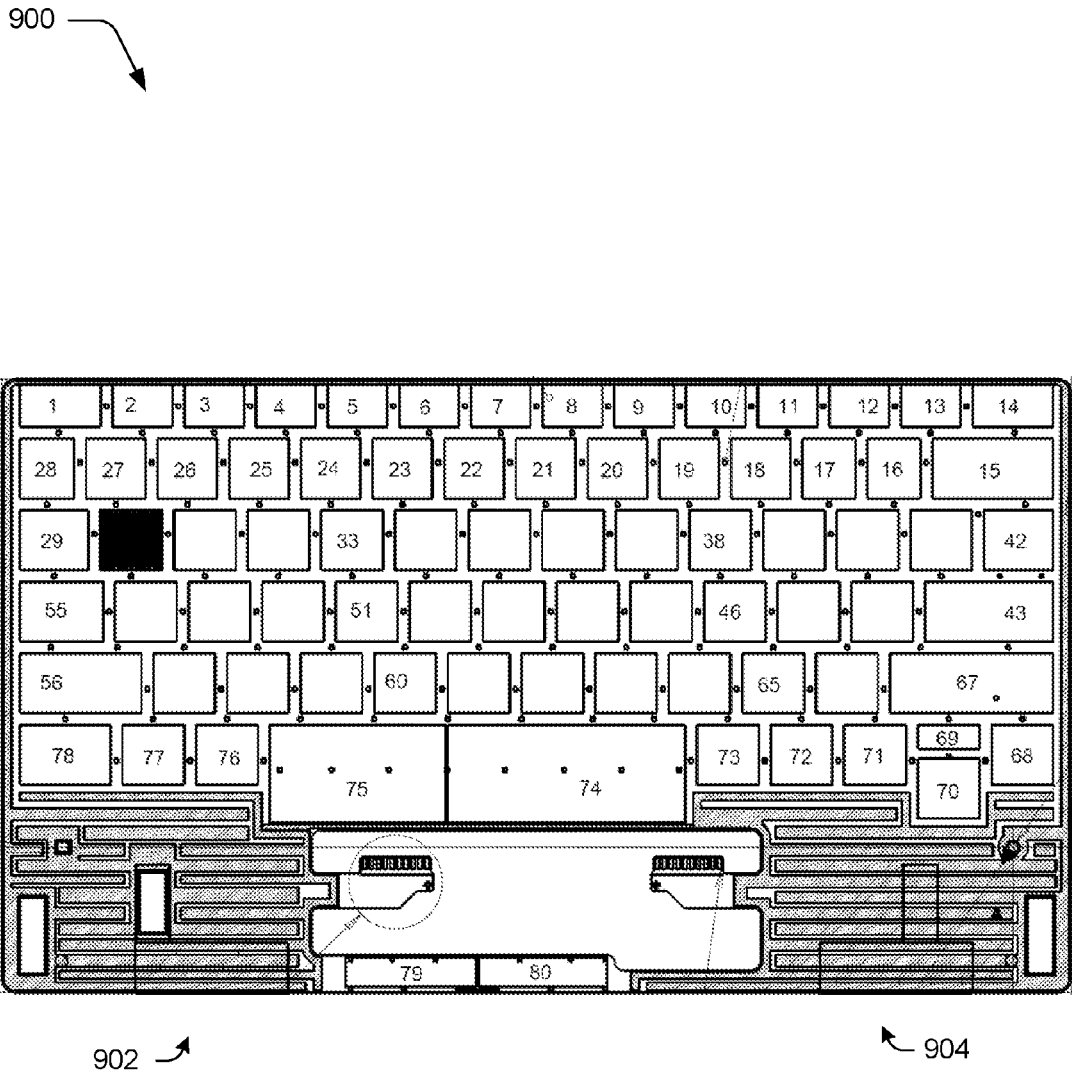


Fig. 9A

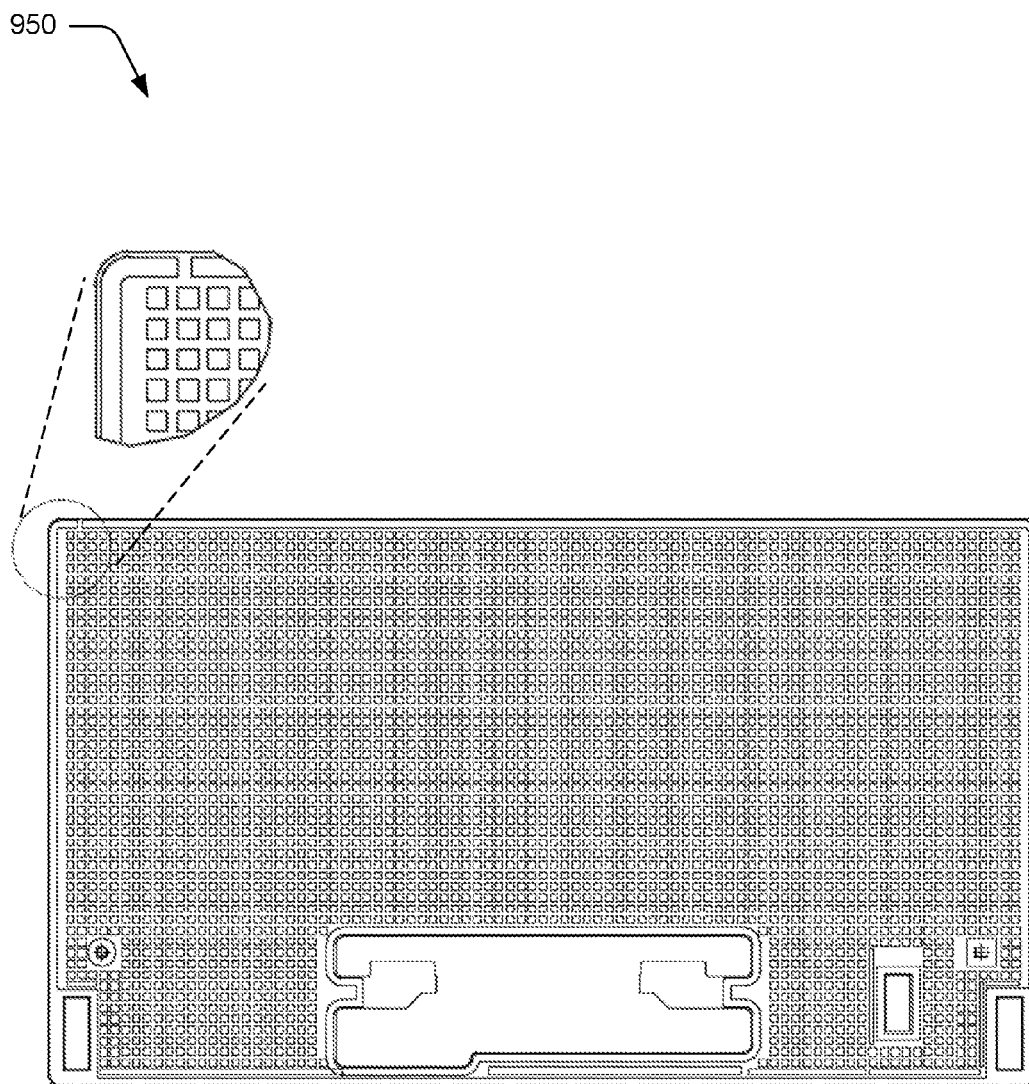


Fig. 9B

1000

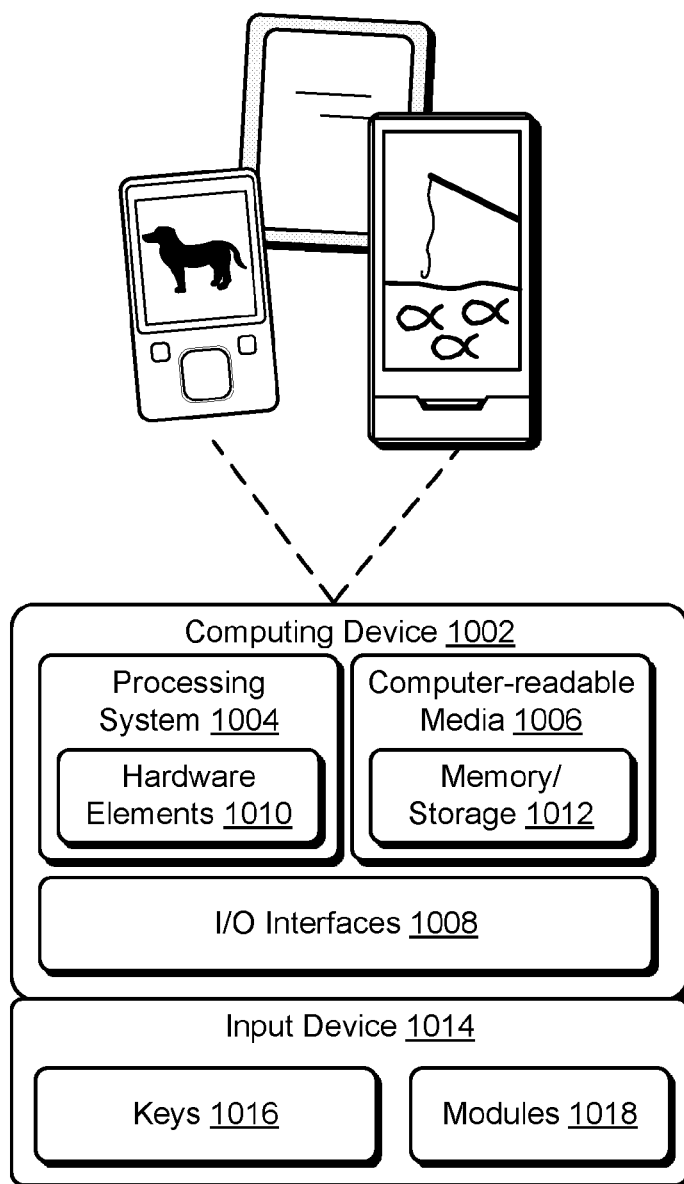


Fig. 10

INPUT DEVICE SECURING TECHNIQUES

RELATED APPLICATIONS

[0001] This application claims priority under 35 U.S.C. §120 as a divisional of U.S. patent application Ser. No. 14/307,262, filed Jun. 17, 2014 and titled “Input Device Securing Techniques”, which claims priority under 35 U.S.C. §120 as a continuation to U.S. patent application Ser. No. 13/471,139, filed May 14, 2012 and titled “Input Device Securing Techniques”, which claims priority under 35 U.S.C. §119(e) to the following U.S. Provisional patent applications, the entire disclosures of each of the applications being incorporated by reference in their entirety:

[0002] U.S. Provisional Patent Application No. 61/606,321, filed Mar. 2, 2012, Attorney Docket Number 336082.01, and titled “Screen Edge;”

[0003] U.S. Provisional Patent Application No. 61/606,301, filed Mar. 2, 2012, Attorney Docket Number 336083.01, and titled “Input Device Functionality;”

[0004] U.S. Provisional Patent Application No. 61/606,313, filed Mar. 2, 2012, Attorney Docket Number 336084.01, and titled “Functional Hinge;”

[0005] U.S. Provisional Patent Application No. 61/606,333, filed Mar. 2, 2012, Attorney Docket Number 336086.01, and titled “Usage and Authentication;”

[0006] U.S. Provisional Patent Application No. 61/613,745, filed Mar. 21, 2012, Attorney Docket Number 336086.02, and titled “Usage and Authentication;”

[0007] U.S. Provisional Patent Application No. 61/606,336, filed Mar. 2, 2012, Attorney Docket Number 336087.01, and titled “Kickstand and Camera;” and

[0008] U.S. Provisional Patent Application No. 61/607,451, filed Mar. 6, 2012, Attorney Docket Number 336143.01, and titled “Spanaway Provisional.”

BACKGROUND

[0009] Mobile computing devices have been developed to increase the functionality that is made available to users in a mobile setting. For example, a user may interact with a mobile phone, tablet computer, or other mobile computing device to check email, surf the web, compose texts, interact with applications, and so on. However, traditional mobile computing devices often employed a virtual keyboard that was accessed using touchscreen functionality of the device. This was generally employed to maximize an amount of display area of the computing device.

[0010] Use of the virtual keyboard, however, could be frustrating to a user that desired to provide a significant amount of inputs, such as to enter a significant amount of text to compose a long email, document, and so forth. Thus, conventional mobile computing devices were often perceived to have limited usefulness for such tasks, especially in comparison with ease at which users could enter text using a conventional keyboard, e.g., of a conventional desktop computer. Use of the conventional keyboards, though, with the mobile computing device could decrease the mobility of the mobile computing device and thus could make the mobile computing device less suited for its intended use in mobile settings.

SUMMARY

[0011] Input device securing techniques are described. In one or more implementations, a pressure sensitive key

includes a sensor substrate having one or more conductors, a spacer layer, and a flexible contact layer. The spacer layer is disposed proximal to the sensor substrate and has at least one opening that exposes the one or more conductors of the sensor substrate, the opening defining a plurality of edges of the pressure sensitive key. The flexible contact layer is spaced apart from the sensor substrate by the spacer layer and configured to flex through the opening in response to an applied pressure to contact the one or more conductors of the sensor substrate to initiate an input. The flexible contact layer is secured to the spacer layer such that at a first edge, the flexible contact layer is secured to the spacer layer at an approximate midpoint of the first edge and is not secured to the spacer along another portion of the first edge and at a second edge, the flexible contact layer is not secured to the spacer layer along an approximate midpoint of the second edge.

[0012] In one or more implementations, an input device includes a sensor substrate having a first set of one or more conductors of a first pressure sensitive key and a second set of one or more conductors of a second pressure sensitive key, a spacer layer disposed proximal to the sensor substrate and having first and second openings that expose the first and second sets of conductors, respectively, and a flexible contact layer spaced apart from the sensor substrate by the spacer layer. The flexible contact layer is configured to flex through the first and second openings responsive to an applied pressure to contact, respectively, the first and second sets of conductors to initiate respective first and second inputs. An arrangement of adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the first pressure sensitive key is different than an arrangement of adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the second pressure sensitive key.

[0013] In one or more implementations, an input device includes a sensor substrate having a plurality of sets of one or more conductors of a respective plurality of pressure sensitive keys, a spacer layer disposed proximal to the sensor substrate and having a plurality of openings that expose the plurality of sets of conductors, respectively, a flexible contact layer, and a press equalization device. The flexible contact layer is spaced apart from the sensor substrate by the spacer layer and configured to flex through the plurality of openings responsive to respective applied pressures to respective sets of conductors to initiate respective inputs. The pressure equalization device is formed as a series of connected channels that connect one or more of the plurality of openings to an outside area of the input device to permit air pressure of the outside area to generally equalize with air pressure within the one or more of the plurality of openings.

[0014] This Summary is provided to introduce a selection of concepts in a simplified form that are further described below in the Detailed Description. This Summary is not intended to identify key features or essential features of the claimed subject matter, nor is it intended to be used as an aid in determining the scope of the claimed subject matter.

BRIEF DESCRIPTION OF THE DRAWINGS

[0015] The detailed description is described with reference to the accompanying figures. In the figures, the left-most digit(s) of a reference number identifies the figure in which the reference number first appears. The use of the

same reference numbers in different instances in the description and the figures may indicate similar or identical items. Entities represented in the figures may be indicative of one or more entities and thus reference may be made interchangeably to single or plural forms of the entities in the discussion.

[0016] FIG. 1 is an illustration of an environment in an example implementation that is operable to employ the techniques described herein.

[0017] FIG. 2 depicts an example implementation of an input device of FIG. 1 as showing a flexible hinge in greater detail.

[0018] FIG. 3 depicts an example implementation showing a perspective view of a connecting portion of FIG. 2 that includes mechanical coupling protrusions and a plurality of communication contacts.

[0019] FIG. 4 depicts an example of a cross-sectional view of a pressure sensitive key of a keyboard of the input device of FIG. 2.

[0020] FIG. 5 depicts an example of a pressure sensitive key of FIG. 4 as having pressure applied at a first location of a flexible contact layer to cause contact with a corresponding first location of a sensor substrate.

[0021] FIG. 6 depicts an example of the pressure sensitive key of FIG. 4 as having pressure applied at a second location of the flexible contact layer to cause contact with a corresponding second location of the sensor substrate.

[0022] FIG. 7 depicts a bottom view of a pressure sensitive key of FIG. 4 as having a flexible contact layer secured at a plurality of locations along edges of the key.

[0023] FIG. 8 depicts another version of FIG. 7 in which a securing portion is moved to a different location along an edge of the key.

[0024] FIG. 9A depicts an example of an adhesive layer applied as part of a keyboard having a plurality of keys in which different arrangements of adhesive are used for different keys.

[0025] FIG. 9B depicts another example implementation of a layer incorporating a matric that may be used to reduce air entrapment.

[0026] FIG. 10 illustrates an example system including various components of an example device that can be implemented as any type of computing device as described with reference to FIGS. 1-9 to implement embodiments of the techniques described herein.

DETAILED DESCRIPTION

[0027] Overview

[0028] Pressure sensitive keys may be used as part of an input device to support a relatively thin form factor, such as approximately three millimeters. However, pressure sensitive keys may not provide a degree of feedback that is common with conventional mechanical keyboards and therefore may result in missed hits and partial hits to intended keys of the keyboard. Further, conventional configuration of the pressure sensitive keys often resulted in different sensitivities due to the flexibility of the material being deflected, e.g., greater deflection is generally observed at a central area of the key as opposed to an edge of the key. Therefore, conventional pressure sensitive keys could result in an inconsistent user experience with a device that employs the keys.

[0029] Input device securing techniques are described. In one or more implementations, a pressure sensitive key is

configured to provide a normalized output, e.g., to counteract differences in the flexibility at different positions of the pressure sensitive key. For example, sensitivity at an edge of a key may be increased in comparison with the sensitivity at a center of the key to address the differences in flexibility of the key at those positions.

[0030] The sensitivity may be adjusted in a variety of ways. For example, sensitivity may be adjusted by arrangement of support structure and/or adhesives used to secure a flexible contact layer to a spacer layer. This may be used to alter flexibility along different locations along an edge of the key. Sensitivity may also be adjusted for different keys. For example, depending on a location on a keyboard, different keys may be pressed using different fingers as well as different parts of a finger. Accordingly, arrangement of the adhesive may also be performed to address these differences. Further discussion of these and other features including formation and use of a pressure equalization device may be found in relation to the following sections.

[0031] In the following discussion, an example environment is first described that may employ the techniques described herein. Example procedures are then described which may be performed in the example environment as well as other environments. Consequently, performance of the example procedures is not limited to the example environment and the example environment is not limited to performance of the example procedures.

[0032] Example Environment

[0033] FIG. 1 is an illustration of an environment 100 in an example implementation that is operable to employ the techniques described herein. The illustrated environment 100 includes an example of a computing device 102 that is physically and communicatively coupled to an input device 104 via a flexible hinge 106. The computing device 102 may be configured in a variety of ways. For example, the computing device 102 may be configured for mobile use, such as a mobile phone, a tablet computer as illustrated, and so on. Thus, the computing device 102 may range from full resource devices with substantial memory and processor resources to a low-resource device with limited memory and/or processing resources. The computing device 102 may also relate to software that causes the computing device 102 to perform one or more operations.

[0034] The computing device 102, for instance, is illustrated as including an input/output module 108. The input/output module 108 is representative of functionality relating to processing of inputs and rendering outputs of the computing device 102. A variety of different inputs may be processed by the input/output module 108, such as inputs relating to functions that correspond to keys of the input device 104, keys of a virtual keyboard displayed by the display device 110 to identify gestures and cause operations to be performed that correspond to the gestures that may be recognized through the input device 104 and/or touchscreen functionality of the display device 110, and so forth. Thus, the input/output module 108 may support a variety of different input techniques by recognizing and leveraging a division between types of inputs including key presses, gestures, and so on.

[0035] In the illustrated example, the input device 104 is configured as a keyboard having a QWERTY arrangement of keys although other arrangements of keys are also contemplated. Further, other non-conventional configurations are also contemplated, such as a game controller, configu-

ration to mimic a musical instrument, and so forth. Thus, the input device **104** and keys incorporated by the input device **104** may assume a variety of different configurations to support a variety of different functionality.

[0036] As previously described, the input device **104** is physically and communicatively coupled to the computing device **102** in this example through use of a flexible hinge **106**. The flexible hinge **106** is flexible in that rotational movement supported by the hinge is achieved through flexing (e.g., bending) of the material forming the hinge as opposed to mechanical rotation as supported by a pin, although that embodiment is also contemplated. Further, this flexible rotation may be configured to support movement in one direction (e.g., vertically in the figure) yet restrict movement in other directions, such as lateral movement of the input device **104** in relation to the computing device **102**. This may be used to support consistent alignment of the input device **104** in relation to the computing device **102**, such as to align sensors used to change power states, application states, and so on.

[0037] The flexible hinge **106**, for instance, may be formed using one or more layers of fabric and include conductors formed as flexible traces to communicatively couple the input device **104** to the computing device **102** and vice versa. This communication, for instance, may be used to communicate a result of a key press to the computing device **102**, receive power from the computing device, perform authentication, provide supplemental power to the computing device **102**, and so on. The flexible hinge **106** may be configured in a variety of ways, further discussion of which may be found in relation to the following figure.

[0038] FIG. 2 depicts an example implementation **200** of the input device **104** of FIG. 1 as showing the flexible hinge **106** in greater detail. In this example, a connection portion **202** of the input device is shown that is configured to provide a communicative and physical connection between the input device **104** and the computing device **102**. In this example, the connection portion **202** has a height and cross section configured to be received in a channel in the housing of the computing device **102**, although this arrangement may also be reversed without departing from the spirit and scope thereof.

[0039] The connection portion **202** is flexibly connected to a portion of the input device **104** that includes the keys through use of the flexible hinge **106**. Thus, when the connection portion **202** is physically connected to the computing device the combination of the connection portion **202** and the flexible hinge **106** supports movement of the input device **104** in relation to the computing device **102** that is similar to a hinge of a book.

[0040] For example, rotational movement may be supported by the flexible hinge **106** such that the input device **104** may be placed against the display device **110** of the computing device **102** and thereby act as a cover. The input device **104** may also be rotated so as to be disposed against a back of the computing device **102**, e.g., against a rear housing of the computing device **102** that is disposed opposite the display device **110** on the computing device **102**.

[0041] Naturally, a variety of other orientations are also supported. For instance, the computing device **102** and input device **104** may assume an arrangement such that both are laid flat against a surface as shown in FIG. 1. In another instance, a typing arrangement may be supported in which

the input device **104** is laid flat against a surface and the computing device **102** is disposed at an angle to permit viewing of the display device **110**, e.g., such as through use of a kickstand disposed on a rear surface of the computing device **102**. Other instances are also contemplated, such as a tripod arrangement, meeting arrangement, presentation arrangement, and so forth.

[0042] The connecting portion **202** is illustrated in this example as including magnetic coupling devices **204**, **206**, mechanical coupling protrusions **208**, **210**, and a plurality of communication contacts **212**. The magnetic coupling devices **204**, **206** are configured to magnetically couple to complementary magnetic coupling devices of the computing device **102** through use of one or more magnets. In this way, the input device **104** may be physically secured to the computing device **102** through use of magnetic attraction.

[0043] The connecting portion **202** also includes mechanical coupling protrusions **208**, **210** to form a mechanical physical connection between the input device **104** and the computing device **102**. The mechanical coupling protrusions **208**, **210** are shown in greater detail in the following figure.

[0044] FIG. 3 depicts an example implementation **300** shown a perspective view of the connecting portion **202** of FIG. 2 that includes the mechanical coupling protrusions **208**, **210** and the plurality of communication contacts **212**. As illustrated, the mechanical coupling protrusions **208**, **210** are configured to extend away from a surface of the connecting portion **202**, which in this case is perpendicular although other angles are also contemplated.

[0045] The mechanical coupling protrusions **208**, **210** are configured to be received within complimentary cavities within the channel of the computing device **102**. When so received, the mechanical coupling protrusions **208**, **210** promote a mechanical binding between the devices when forces are applied that are not aligned with an axis that is defined as correspond to the height of the protrusions and the depth of the cavity.

[0046] For example, when a force is applied that does coincide with the longitudinal axis described previously that follows the height of the protrusions and the depth of the cavities, a user overcomes the force applied by the magnets solely to separate the input device **104** from the computing device **102**. However, at other angles the mechanical coupling protrusion **208**, **210** are configured to mechanically bind within the cavities, thereby creating a force to resist removal of the input device **104** from the computing device **102** in addition to the magnetic force of the magnetic coupling devices **204**, **206**. In this way, the mechanical coupling protrusions **208**, **210** may bias the removal of the input device **104** from the computing device **102** to mimic tearing a page from a book and restrict other attempts to separate the devices.

[0047] The connecting portion **202** is also illustrated as including a plurality of communication contacts **212**. The plurality of communication contacts **212** is configured to contact corresponding communication contacts of the computing device **102** to form a communicative coupling between the devices. The communication contacts **212** may be configured in a variety of ways, such as through formation using a plurality of spring loaded pins that are configured to provide a consistent communication contact between the input device **104** and the computing device **102**. Therefore, the communication contact may be configured to remain during minor movement of jostling of the devices. A

variety of other examples are also contemplated, including placement of the pins on the computing device 102 and contacts on the input device 104.

[0048] FIG. 4 depicts an example of a cross-sectional view of a pressure sensitive key 400 of a keyboard of the input device 104 of FIG. 2. The pressure sensitive key 400 in this example is illustrated as being formed using a flexible contact layer 402 (e.g., Mylar) that is spaced apart from the sensor substrate 404 using a spacer layer 406, 408, which may be formed as another layer of Mylar or other bendable material, formed on the sensor substrate 404, and so on. In this example, the flexible contact layer 402 does not contact the sensor substrate 404 absent application of pressure against the flexible contact layer 402.

[0049] The flexible contact layer 402 in this example includes a force sensitive ink 410 disposed on a surface of the flexible contact layer 402 that is configured to contact the sensor substrate 404. The force sensitive ink 410 is configured such that an amount of resistance of the ink varies directly in relation to an amount of pressure applied. The force sensitive ink 410, for instance, may be configured with a relatively rough surface that is compressed against the sensor substrate 404 upon an application of pressure against the flexible contact layer 402. The greater the amount of pressure, the more the force sensitive ink 410 is compressed, thereby increasing conductivity and decreasing resistance of the force sensitive ink 410. Other conductors may also be disposed on the flexible contact layer 402 without departing from the spirit and scope therefore, including other types of pressure sensitive and non-pressure sensitive conductors.

[0050] The sensor substrate 404 includes a one or more conductors 412 disposed thereon that are configured to be contacted by the force sensitive ink 410 of the flexible contact layer 402. When contacted, an analog signal may be generated for processing by the input device 104 and/or the computing device 102, e.g., to recognize whether the signal is likely intended by a user to provide an input for the computing device 102. A variety of different types of conductors 412 may be disposed on the sensor substrate 404, such as formed from a variety of conductive materials (e.g., silver, copper), disposed in a variety of different configurations such as inter-digitated trace fingers, support use of a single conductor, and so on.

[0051] FIG. 5 depicts an example 500 of the pressure sensitive key 400 of FIG. 4 as having pressure applied at a first location of the flexible contact layer 402 to cause contact of the force sensitive ink 410 with a corresponding first location of the sensor substrate 404. The pressure is illustrated through use of an arrow in FIG. 5 and may be applied in a variety of ways, such as by a finger of a user's hand, stylus, pen, and so on. In this example, the first location at which pressure is applied as indicated by the arrow is located generally near a center region of the flexible contact layer 402 that is disposed between the spacer layers 406, 408. Due to this location, the flexible contact layer 402 may be considered generally flexible (e.g., bendable and/or stretchable) and thus responsive to the pressure.

[0052] This flexibility permits a relatively large area of the flexible contact layer 402, and thus the force sensitive ink 410, to contact the conductors 412 of the sensor substrate 404. Thus, a relatively strong signal may be generated. Further, because the flexibility of the flexible contact layer 402 is relatively high at this location, a relatively large amount of the force may be transferred through the flexible

contact layer 402, thereby applying this pressure to the force sensitive ink 410. As previously described, this increase in pressure may cause a corresponding increase in conductivity of the force sensitive ink and decrease in resistance of the ink. Thus, the relatively high amount of flexibility of the flexible contact layer at the first location may cause a relatively stronger signal to be generated in comparison with other locations of the flexible contact layer 402 that located closer to an edge of the key, an example of which is described in relation to the following figure.

[0053] FIG. 6 depicts an example 600 of the pressure sensitive key 400 of FIG. 4 as having pressure applied at a second location of the flexible contact layer 402 to cause contact with a corresponding second location of the sensor substrate 404. In this example, the second location of FIG. 6 at which pressure is applied is located closer to an edge of the pressure sensitive key (e.g., closer to an edge of the spacer layer 406) than the first location of FIG. 5. Due to this location, the flexible contact layer 402 has reduced flexibility when compared with the first location and thus less responsive to pressure.

[0054] This reduced flexibility may cause a reduction in an area of the flexible contact layer 402, and thus the force sensitive ink 410, that contacts the conductors 412 of the sensor substrate 404. Thus, a signal produced at the second location may be weaker than a signal produced at the first location of FIG. 5.

[0055] Further, because the flexibility of the flexible contact layer 402 is relatively low at this location, a relatively low amount of the force may be transferred through the flexible contact layer 402, thereby reducing the amount of pressure transmitted to the force sensitive ink 410. As previously described, this decrease in pressure may cause a corresponding decrease in conductivity of the force sensitive ink and increase in resistance of the ink in comparison with the first location of FIG. 5. Thus, the reduced flexibility of the flexible contact layer 402 at the second location in comparison with the first location may cause a relatively weaker signal to be generated. Further, this situation may be exacerbated by a partial hit in which a smaller portion of the user's finger is able to apply pressure at the second location of FIG. 6 in comparison with the first location of FIG. 5.

[0056] However, as previously described adhesive used to secure the flexible contact layer 402 with the spacer layer 406 may be arranged (e.g., patterned) to promote flexibility of the flexible contact layer 402 at desired locations of the key, further discussion of which may be found in relation to the following figure.

[0057] FIG. 7 depicts a top view 700 of a pressure sensitive key of FIG. 4 as having the flexible contact layer 402 secured at a plurality of locations along edges of the key. First, second, third, and fourth edges 702, 704, 706, 708 are illustrated in this example as defining an opening 710 of a spacer layer 406/408 of a pressure sensitive key. The opening 710 as described in relation to FIGS. 4-6 permits the flexible contact layer 402 to flex (e.g., bend and/or stretch) through the opening 710 to contact the one or more conductors 412 of the sensor substrate 404.

[0058] In the illustrated example, a first securing portion 712 is illustrated as disposed proximal to the first edge 702 of the opening 710. Likewise, second, third, and fourth securing portions 714, 716, 718 are illustrated as disposed proximal to respective second, third, and fourth edges 704, 706, 708 of the opening 710. The securing portions may be

configured in a variety of ways, such as through use of an adhesive, mechanical securing device (e.g., pins), and so on. Furthermore, securing portions may be configured without adhesive and only provide structure integrity. For example, the structural support and/or adhesive may be applied as a series of dots or other shapes to the spacer layer **406** which is then contacted (e.g., pressed) to the flexible contact layer **402**.

[0059] Regardless of the technique used to secure the flexible contact layer **402** to the spacer layer **406**, flexibility may be configured as desired by permitting portions of the flexible contact layer **402** along the edge of the opening to remain unsecured. For instance, the first and second securing portions **714**, **716** may define sole areas at which the flexible contact layer **402** is secured to the spacer layer **406** along the respective first and second edges **702**, **704**. Therefore, flexibility of the flexible contact layer **402** may decrease as a distance between a point of contact of the pressure and a securing portion decreases similar to the edge discussion of FIGS. **5** and **6**, such as due to sliding of the flexible contact layer over the edge, permit increased stretching, and so forth.

[0060] However, the reverse is also true in that flexibility increases the further away pressure is applied from the securing portions. Thus, flexibility along the edges of the opening **710** may be increased by including portions along an edge at which the flexible contact layer **402** is not secured (proximally) to the spacer layer **406**. Thus, different arrangements of how the flexible contact layer **402** is secured to the spacer layer **404** may be used to support different amounts of flexibility at different locations of the flexible contact layer **402**.

[0061] For example, as illustrated the first and second securing portions **712**, **714** are located closer together than the first and third securing portions **712**, **716**. Accordingly, points (e.g., a midpoint) between the first and third securing portions **712**, **716** may have greater flexibility than corresponding points (e.g., a midpoint) between the first and second securing portions **712**, **714**. In this way, a designer may configure the flexible contact surface **402** to increase or decrease flexibility at particular locations as desired.

[0062] In the example **800** of FIG. **8**, for instance, the second securing portion **714** is moved from one end of the second edge **704** to an opposing end of the second edge **704**. Thus, flexibility is increased on the left upper portion of the key in this example and decreased in the upper right portion of the key. A variety of other examples are also contemplated, examples of which are shown in relation to a keyboard in the following example.

[0063] FIG. **9A** depicts an example of a spacer layer **900** applied as part of a keyboard having a plurality of keys in which different arrangements of support structure and/or adhesive are used for different keys. Securing portions in this example are illustrated in shaded (cross hatched) lines in regions of support structure and adhesive while the dots depict only support structure regions that are used to secured the flexible contact layer **402** with the sensor substrate **404**. As shown, different arrangements of the securing portions may be used to address differences in how corresponding keys are likely to be pressed.

[0064] For example, as shown the arrangements of support structure for respective keys in the home row (e.g., keys **43-55**) is different than arrangements of support structure for a row of keys in the next lower row, e.g., keys **56-67**. This

may be performed to address “where” a key is likely to be pressed, such as at a center or particular one of the four sides of the key. This may also be performed to address “how” a key is likely to be pressed, such as using a pad of a finger as opposed to a user’s fingernail, which finger of a user is likely to press the key, and so on. Thus, as illustrated in the example adhesive layer **900** of FIG. **9**, different arrangements may be used for different rows of keys as well as for different columns of the keys.

[0065] The spacer layer **900** in this example is also illustrated as forming first and second pressure equalization devices **902**, **904**. In this example, support structure and/or adhesive is disposed to leave channels formed between the support structure and/or adhesive. Thus, the support structure and/or adhesive defines the channels that form the device. The channels are configured to connect openings **710** formed as part of the pressure sensitive keys between the flexible contact layer **402** and the sensor substrate **404** to an outside environment of the input device **104**.

[0066] In this way, air may move between the outside environment and the openings through the channels to generally equalize the air pressure, which may help prevent damage to the input device **104**, e.g., when faced with reduced air pressure in an airplane. In one or more implementations, the channels may be formed as a labyrinth having a plurality of bends to protect against outside contaminants from passing through the pressure equalization devices **902**, **904** to the openings **710**. In the illustrated example, the pressure equalization devices **902**, **904** are disposed as part of a palm rest of the spacer layer to leverage available space to form longer channels and thus further protect against contamination. Naturally, a wide variety of other examples and locations are also contemplated without departing from the spirit and scope thereof.

[0067] FIG. **9B** depicts another example implementation of a layer **950** incorporating a matrix that may be used to reduce air entrapment. In this example, strategic adhesive placement (or other securing techniques) is used to reduce air entrapment between consecutive layers. In the previous example, a vented labyrinth seal in the sensor substrate/flexible contact layer interface was described.

[0068] In this example, a layer (e.g., below the sensor substrate **202**) is not configured as a “full bleed adhesive sheet,” but instead is a square matrix of adhesive patches that bind the consecutive layers together. This allows easier assembly and eliminates air entrapment between layers. In this way, multiple layers may be bonded together through adhesive construction to achieve thin profile, stiffness, and allow internal electronics nesting of components.

[0069] Example System and Device

[0070] FIG. **10** illustrates an example system generally at **1000** that includes an example computing device **1002** that is representative of one or more computing systems and/or devices that may implement the various techniques described herein. The computing device **1002** may be, for example, be configured to assume a mobile configuration through use of a housing formed and size to be grasped and carried by one or more hands of a user, illustrated examples of which include a mobile phone, mobile game and music device, and tablet computer although other examples are also contemplated.

[0071] The example computing device **1002** as illustrated includes a processing system **1004**, one or more computer-readable media **1006**, and one or more I/O interface **1008**

that are communicatively coupled, one to another. Although not shown, the computing device **1002** may further include a system bus or other data and command transfer system that couples the various components, one to another. A system bus can include any one or combination of different bus structures, such as a memory bus or memory controller, a peripheral bus, a universal serial bus, and/or a processor or local bus that utilizes any of a variety of bus architectures. A variety of other examples are also contemplated, such as control and data lines.

[0072] The processing system **1004** is representative of functionality to perform one or more operations using hardware. Accordingly, the processing system **1004** is illustrated as including hardware element **1010** that may be configured as processors, functional blocks, and so forth. This may include implementation in hardware as an application specific integrated circuit or other logic device formed using one or more semiconductors. The hardware elements **1010** are not limited by the materials from which they are formed or the processing mechanisms employed therein. For example, processors may be comprised of semiconductor(s) and/or transistors (e.g., electronic integrated circuits (ICs)). In such a context, processor-executable instructions may be electronically-executable instructions.

[0073] The computer-readable storage media **1006** is illustrated as including memory/storage **1012**. The memory/storage **1012** represents memory/storage capacity associated with one or more computer-readable media. The memory/storage component **1012** may include volatile media (such as random access memory (RAM)) and/or nonvolatile media (such as read only memory (ROM), Flash memory, optical disks, magnetic disks, and so forth). The memory/storage component **1012** may include fixed media (e.g., RAM, ROM, a fixed hard drive, and so on) as well as removable media (e.g., Flash memory, a removable hard drive, an optical disc, and so forth). The computer-readable media **1006** may be configured in a variety of other ways as further described below.

[0074] Input/output interface(s) **1008** are representative of functionality to allow a user to enter commands and information to computing device **1002**, and also allow information to be presented to the user and/or other components or devices using various input/output devices. Examples of input devices include a keyboard, a cursor control device (e.g., a mouse), a microphone, a scanner, touch functionality (e.g., capacitive or other sensors that are configured to detect physical touch), a camera (e.g., which may employ visible or non-visible wavelengths such as infrared frequencies to recognize movement as gestures that do not involve touch), and so forth. Examples of output devices include a display device (e.g., a monitor or projector), speakers, a printer, a network card, tactile-response device, and so forth. Thus, the computing device **1002** may be configured in a variety of ways to support user interaction.

[0075] The computing device **1002** is further illustrated as being communicatively and physically coupled to an input device **1014** that is physically and communicatively removable from the computing device **1002**. In this way, a variety of different input devices may be coupled to the computing device **1002** having a wide variety of configurations to support a wide variety of functionality. In this example, the input device **1014** includes one or more keys **1016**, which may be configured as pressure sensitive keys, mechanically switched keys, and so forth.

[0076] The input device **1014** is further illustrated as include one or more modules **1018** that may be configured to support a variety of functionality. The one or more modules **1018**, for instance, may be configured to process analog and/or digital signals received from the keys **1016** to determine whether a keystroke was intended, determine whether an input is indicative of resting pressure, support authentication of the input device **1014** for operation with the computing device **1002**, and so on.

[0077] Various techniques may be described herein in the general context of software, hardware elements, or program modules. Generally, such modules include routines, programs, objects, elements, components, data structures, and so forth that perform particular tasks or implement particular abstract data types. The terms “module,” “functionality,” and “component” as used herein generally represent software, firmware, hardware, or a combination thereof. The features of the techniques described herein are platform-independent, meaning that the techniques may be implemented on a variety of commercial computing platforms having a variety of processors.

[0078] An implementation of the described modules and techniques may be stored on or transmitted across some form of computer-readable media. The computer-readable media may include a variety of media that may be accessed by the computing device **1002**. By way of example, and not limitation, computer-readable media may include “computer-readable storage media” and “computer-readable signal media.”

[0079] “Computer-readable storage media” may refer to media and/or devices that enable persistent and/or non-transitory storage of information in contrast to mere signal transmission, carrier waves, or signals per se. Thus, computer-readable storage media refers to non-signal bearing media. The computer-readable storage media includes hardware such as volatile and non-volatile, removable and non-removable media and/or storage devices implemented in a method or technology suitable for storage of information such as computer readable instructions, data structures, program modules, logic elements/circuits, or other data. Examples of computer-readable storage media may include, but are not limited to, RAM, ROM, EEPROM, flash memory or other memory technology, CD-ROM, digital versatile disks (DVD) or other optical storage, hard disks, magnetic cassettes, magnetic tape, magnetic disk storage or other magnetic storage devices, or other storage device, tangible media, or article of manufacture suitable to store the desired information and which may be accessed by a computer.

[0080] “Computer-readable signal media” may refer to a signal-bearing medium that is configured to transmit instructions to the hardware of the computing device **1002**, such as via a network. Signal media typically may embody computer readable instructions, data structures, program modules, or other data in a modulated data signal, such as carrier waves, data signals, or other transport mechanism. Signal media also include any information delivery media. The term “modulated data signal” means a signal that has one or more of its characteristics set or changed in such a manner as to encode information in the signal. By way of example, and not limitation, communication media include wired media such as a wired network or direct-wired connection, and wireless media such as acoustic, RF, infrared, and other wireless media.

[0081] As previously described, hardware elements 1010 and computer-readable media 1006 are representative of modules, programmable device logic and/or fixed device logic implemented in a hardware form that may be employed in some embodiments to implement at least some aspects of the techniques described herein, such as to perform one or more instructions. Hardware may include components of an integrated circuit or on-chip system, an application-specific integrated circuit (ASIC), a field-programmable gate array (FPGA), a complex programmable logic device (CPLD), and other implementations in silicon or other hardware. In this context, hardware may operate as a processing device that performs program tasks defined by instructions and/or logic embodied by the hardware as well as a hardware utilized to store instructions for execution, e.g., the computer-readable storage media described previously.

[0082] Combinations of the foregoing may also be employed to implement various techniques described herein. Accordingly, software, hardware, or executable modules may be implemented as one or more instructions and/or logic embodied on some form of computer-readable storage media and/or by one or more hardware elements 1010. The computing device 1002 may be configured to implement particular instructions and/or functions corresponding to the software and/or hardware modules. Accordingly, implementation of a module that is executable by the computing device 1002 as software may be achieved at least partially in hardware, e.g., through use of computer-readable storage media and/or hardware elements 1010 of the processing system 1004. The instructions and/or functions may be executable/operable by one or more articles of manufacture (for example, one or more computing devices 1002 and/or processing systems 1004) to implement techniques, modules, and examples described herein.

CONCLUSION

[0083] Although the example implementations have been described in language specific to structural features and/or methodological acts, it is to be understood that the implementations defined in the appended claims is not necessarily limited to the specific features or acts described. Rather, the specific features and acts are disclosed as example forms of implementing the claimed features.

What is claimed is:

1. An input device comprising:
 - a sensor substrate having a first set of one or more conductors of a first key and a second set of one or more conductors of a second key;
 - a spacer layer disposed proximal to the sensor substrate and having first and second openings that expose the first and second sets of conductors, respectively; and
 - a flexible contact layer spaced apart from the sensor substrate by the spacer layer and configured to flex through the first and second openings responsive to an applied pressure to initiate respective first and second inputs, in which an arrangement of discrete portions of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the first key is different than an arrangement of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the second key.
2. An input device as described in claim 1, wherein the arrangements define portions along the edges of the first and

second keys, respectively, that do not include adhesive thereby permitting greater flexibility of the flexible contact layer to contact the sensor substrate at a location disposed proximal the portion of the edge that does not include the adhesive in comparison with a portion of the edge that does include the adhesive.

3. An input device as described in claim 1, wherein the input device comprises a keyboard.

4. An input device as described in claim 1, wherein the first key is configured for inclusion as part of a home row of a keyboard.

5. An input device as described in claim 1, wherein the first key is configured for inclusion as part of a home row of a keyboard and the second key is not included as part of the home row of the keyboard.

6. An input device as described in claim 1, wherein the arrangements are configured to address a likelihood of missed hits of the respective first and second keys.

7. An input device as described in claim 1, wherein the first and second keys are configured to provide inputs describing an amount of the pressure received.

8. An input device as described in claim 1, wherein the flexible contact layer includes a force sensitive ink.

9. An input device comprising:

- a sensor substrate having a first set of one or more conductors of a first key and a second set of one or more conductors of a second key;
- a spacer layer disposed proximal to the sensor substrate and having first and second openings that expose the first and second sets of conductors, respectively; and
- a flexible contact layer spaced apart from the sensor substrate by the spacer layer and configured to flex through the first and second openings responsive to an applied pressure to initiate respective first and second inputs, in which flexibility at locations of the first key is different than flexibility at corresponding locations of the second key through arrangement of discrete portions of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the respective first and second keys.

10. An input device as described in claim 9, wherein the arrangements define portions along the edges of the first and second keys, respectively, that do not include adhesive thereby permitting greater flexibility of the flexible contact layer to contact the sensor substrate at a location disposed proximal the portion of the edge that does not include the adhesive in comparison with a portion of the edge that does include the adhesive.

11. An input device as described in claim 9, wherein the first key is configured for inclusion as part of a home row of a keyboard and the second key is not included as part of the home row of the keyboard.

12. An input device as described in claim 9, wherein the arrangements are configured to address a likelihood of missed hits of the respective first and second keys.

13. An input device as described in claim 9, wherein the first and second keys are configured to provide inputs describing an amount of the pressure received.

14. A keyboard device comprising:

- a sensor substrate having a first set of one or more conductors of a first key of the keyboard and a second set of one or more conductors of a second key of the keyboard;

a spacer layer disposed proximal to the sensor substrate and having first and second openings that expose the first and second sets of conductors, respectively; and
a flexible contact layer spaced apart from the sensor substrate by the spacer layer and configured to flex through the first and second openings responsive to an applied pressure to initiate respective first and second inputs.

15. A keyboard device as described in claim **14**, wherein an arrangement of discrete portions of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the first key is different than an arrangement of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the second key.

16. A keyboard device as described in claim **15**, wherein the arrangements define portions along the edges of the first and second keys, respectively, that do not include adhesive thereby permitting greater flexibility of the flexible contact layer to contact the sensor substrate at a location disposed proximal the portion of the edge that does not include the adhesive in comparison with a portion of the edge that does include the adhesive.

17. A keyboard device as described in claim **14**, wherein the first key is configured for inclusion as part of a home row of a keyboard.

18. A keyboard device as described in claim **14**, wherein the first key is configured for inclusion as part of a home row of a keyboard and the second key is not included as part of the home row of the keyboard.

19. A keyboard device as described in claim **14**, wherein flexibility at locations of the first key is different than flexibility at corresponding locations of the second key through arrangement of discrete portions of applied adhesive that secures the flexible contact layer to the spacer layer along one or more edges of the respective first and second keys.

20. A keyboard device as described in claim **14**, wherein the arrangements define portions along the edges of the first and second keys, respectively, that do not include adhesive thereby permitting greater flexibility of the flexible contact layer to contact the sensor substrate at a location disposed proximal the portion of the edge that does not include the adhesive in comparison with a portion of the edge that does include the adhesive.

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